



50V PNP SMALL SIGNAL TRANSISTOR IN X2-DFN1006-3

Features

- BV_{CEO} > -50V
- I_C = -100mA High Collector Current
- P_D = 1000mW Power Dissipation
- 0.60mm² Package Footprint, 13 Times Smaller than SOT23
- 0.4mm Height Package Minimizing Off-Board Profile
- Complementary NPN Type: DN0150BLP4
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

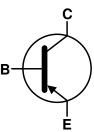
Mechanical Data

- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu.
 Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0008 grams (Approximate)

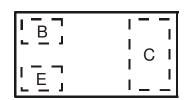
X2-DFN1006-3



Bottom View



Device Symbol



Top View Pin Configuration

Ordering Information (Note 4)

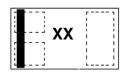
| Part Number | Status | Marking | Reel Size (inches) | Tape Width (mm) | Quantity per Reel |
|---------------|----------|---------|--------------------|-----------------|-------------------|
| DP0150ALP4-7 | Obsolete | T5 | 7 | 8 | 3,000 |
| DP0150ALP4-7B | Obsolete | T5 | 7 | 8 | 10,000 |
| DP0150BLP4-7 | Active | T6 | 7 | 8 | 3,000 |
| DP0150BLP4-7B | Active | T6 | 7 | 8 | 10,000 |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

X2-DFN1006-3



XX = Product Type Marking Code



Absolute Maximum Ratings (@ TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--------------------------------|----------------|-------|------|
| Collector-Base Voltage | V_{CBO} | -50 | V |
| Collector-Emitter Voltage | V_{CEO} | -50 | V |
| Emitter-Base Voltage | V_{EBO} | -5 | V |
| Collector Current - Continuous | Ic | -100 | mA |
| Peak Pulse Collector Current | Ісм | -200 | mA |
| Base Current | Ι _Β | -30 | mA |

Thermal Characteristics (@ TA = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit | |
|---|-----------------------------------|----------------|-------|------|--|
| Dawer Dissination | (Note 5) | D | 400 | mW | |
| Power Dissipation | (Note 6) | P _D | 1000 | | |
| Thermal Resistance, Junction to Ambient | (Note 5) | D | 310 | °C/W | |
| Thermal Resistance, Junction to Ambient | (Note 6) | $R_{	hetaJA}$ | 120 | C/VV | |
| Thermal Resistance, Junction to Lead (Note 7) | | $R_{	heta JL}$ | 120 | °C/W | |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C | | |

ESD Ratings (Note 8)

| Characteristic | Symbol | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 4,000 | V | 3A |
| Electrostatic Discharge - Machine Model | ESD MM | 400 | V | С |

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|--|----------------------|------|------|------|------|---|
| OFF CHARACTERISTICS | | | | | | |
| Collector-Base Breakdown Voltage | BV _{CBO} | -50 | -100 | _ | V | I _C = -100μA |
| Collector-Emitter Breakdown Voltage (Note 8) | BV _{CEO} | -50 | -79 | _ | V | $I_C = -1mA$ |
| Emitter-Base Breakdown Voltage | BV_{EBO} | -6 | -8.3 | _ | V | $I_E = -100\mu A$ |
| Collector Cut-Off Current | I_{CBO} | | -1 | -50 | nA | $V_{CB} = -50V$ |
| Collector Cut-Off Current | I_{CEX} | | -1 | -50 | nA | $V_{CE} = -50V, V_{EB} = -3V$ |
| Emitter Cut-Off Current | I _{EBO} | | -1 | -20 | nA | $V_{EB} = -5V$ |
| Base Cutoff Current | I_{BL} | | -1 | -50 | nA | $V_{CE} = -50V, V_{EB} = -3V$ |
| ON CHARACTERISTICS (Note 9) | | | | | | |
| DC Current Gain DP0150BLP4 | h_{FE} | 200 | 300 | 400 | | $V_{CE} = -6V, I_{C} = -2mA$ |
| Collector-Emitter Saturation Voltage | V _{CE(sat)} | _ | -150 | -300 | mV | $I_C = -100 \text{mA}, I_B = -10 \text{mA}$ |
| Base-Emitter Saturation Voltage | $V_{BE(sat)}$ | -650 | -740 | -850 | mV | $I_C = -10mA$, $I_B = -1mA$ |
| · · | | _ | -830 | -950 | | $I_C = -50 \text{mA}, I_B = -5 \text{mA}$ |
| SMALL SIGNAL CHARACTERISTICS | | | | | | |
| Transition Frequency | f_{T} | 80 | _ | _ | MHz | $V_{CE} = -10V, I_{E} = -1mA$ f = 30MHz |
| Output Capacitance | C _{obo} | | 1.6 | _ | pF | $V_{CB} = -10V, I_{E} = 0,$ f = 1MHz |

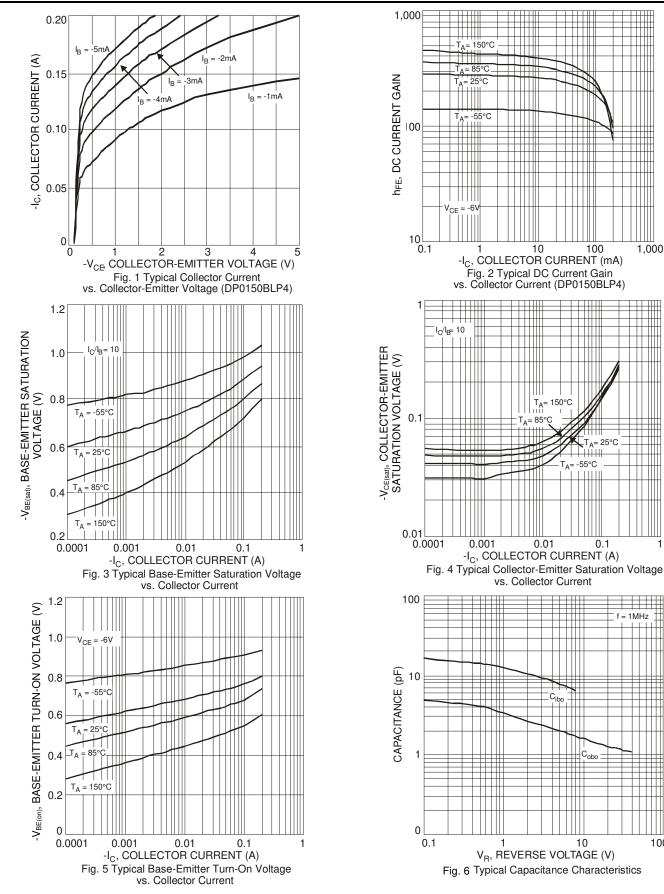
Notes:

- 5. For the device mounted on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady state condition. The entire exposed collector pad is attached to the heatsink.
- 6. Same as Note 5, except the exposed collector pad is mounted on 25mm x 25mm 2oz copper. 7. Thermal resistance from junction to solder-point (on the exposed collector pad).
- 8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.
- 9. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.

1,000



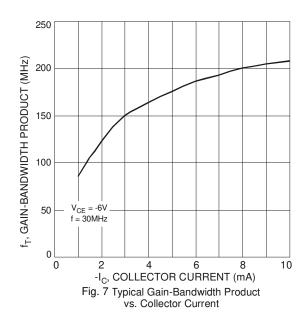
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)



100



Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.) (continued)

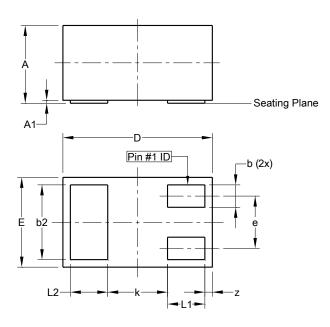




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3

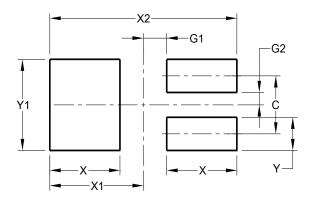


| X2-DFN1006-3 | | | | | |
|----------------------|------|------|------|--|--|
| Dim | Min | Max | Тур | | |
| Α | | 0.40 | | | |
| A 1 | 0.00 | 0.05 | 0.03 | | |
| b | 0.10 | 0.20 | 0.15 | | |
| b2 | 0.45 | 0.55 | 0.50 | | |
| D | 0.95 | 1.05 | 1.00 | | |
| Е | 0.55 | 0.65 | 0.60 | | |
| е | | | 0.35 | | |
| L1 | 0.20 | 0.30 | 0.25 | | |
| L2 | 0.20 | 0.30 | 0.25 | | |
| k | _ | _ | 0.40 | | |
| Z | 0.02 | 0.08 | 0.05 | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3



| Dimensions | value (in mm) |
|------------|---------------|
| С | 0.350 |
| G1 | 0.150 |
| G2 | 0.075 |
| X | 0.450 |
| X1 | 0.600 |
| X2 | 1.200 |
| Υ | 0.200 |
| Y1 | 0.550 |



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